TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (U-MOSVI-H)

TPCA8047-H

Switching Regulator Applications Motor Drive Applications DC-DC Converter Applications

- Small footprint due to a small and thin package
- High-speed switching
- Small gate charge: Q_{SW} = 13 nC (typ.)
- Low drain-source ON-resistance: R_{DS} (ON) = 4.8 $m\Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 92 S$ (typ.)
- Low leakage current: $I_{DSS} = 10 \mu A (max) (V_{DS} = 40 V)$
- Enhancement mode: $V_{th} = 1.3$ to 2.3 V ($V_{DS} = 10$ V, $I_D = 0.5$ mA)

Absolute Maximum Ratings (Ta = 25°C)

Characte	eristic	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	40	V
Drain-gate voltage (R	$k_{GS} = 20 \text{ k}\Omega$)	V_{DGR}	40	V
Gate-source voltage		V_{GSS}	±20	V
Drain current	DC (Note 1)	ΙD	32	Α
Drain current	Pulsed (Note 1)	I_{DP}	96	^
Drain power dissipati	on (Tc = 25°C)	P_{D}	45	W
Drain power dissipati	on (t = 10 s) (Note 2a)	P _D	2.8	W
Drain power dissipati	on (t = 10 s) (Note 2b)	P _D	1.6	W
Single-pulse avalance	ne energy (Note 3)	E _{AS}	95	mJ
Avalanche current		I _{AR}	32	Α
Repetitive avalanche	energy c = 25°C) (Note 4)	E _{AR}	3.95	mJ
Channel temperature		T _{ch}	150	°C
Storage temperature	range	T _{stg}	-55 to 150	°C

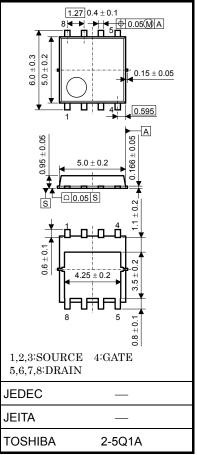
Note: For Notes 1 to 4, refer to the next page.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the

reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

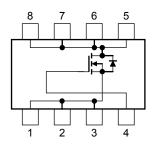
This transistor is an electrostatic-sensitive device. Handle with care.

Unit: mm



Weight: 0.069 g (typ.)

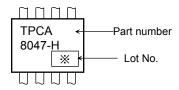
Circuit Configuration



Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case (Tc = 25°C)	R _{th (ch-c)}	2.78	°C/W
Thermal resistance, channel to ambient $(t=10\;s) \eqno(Note\;2a)$	R _{th (ch-a)}	44.6	°C/W
Thermal resistance, channel to ambient $(t = 10 \text{ s})$ (Note 2b)	R _{th (ch-a)}	78.1	°C/W

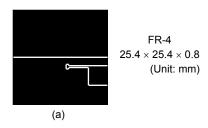
Marking (Note 5)

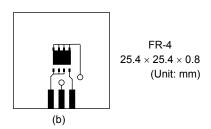


Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a)

(b) Device mounted on a glass-epoxy board (b)

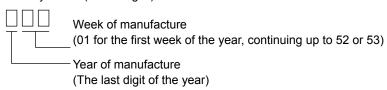




Note 3: V_{DD} = 24 V, T_{ch} = 25°C (initial), L = 100 μ H, R_G = 25 Ω , I_{AR} = 32 A

Note 4: Repetitive rating: pulse width limited by maximum channel temperature

Note 5: * Weekly code: (Three digits)



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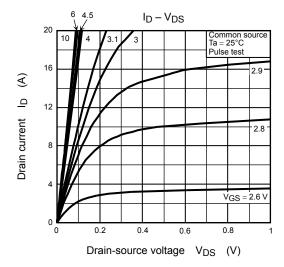
Electrical Characteristics (Ta = 25°C)

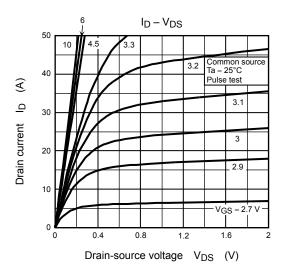
Ch	Characteristic Symbol T		Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±100	nA
Drain cutoff curre	nt	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V	_	_	10	μА
Drain course broa	ce breakdown voltage		_	_	V		
Dialii-source brea	akdown voltage	V (BR) DSX	$I_D = 10$ mA, $V_{GS} = -20$ V	25	— — 10 40 — — 25 — — 1.3 — 2.3 — 6.0 8.5 — 4.8 7.3 46 92 — — 2590 3365 — 135 200 — 440 —	\ \ \	
Gate threshold vo	oltage	V _{th}	$V_{DS} = 10 \text{ V}, I_D = 0.5 \text{ mA}$	1.3	_	2.3	V
Drain-source ON-	resistance	Pro (ON)	$V_{GS} = 4.5 \text{ V}, I_D = 16 \text{ A}$		6.0	8.5	mΩ
Dialii-source Oil	-iesistarice	R _{DS} (ON)	V _{GS} = 10 V, I _D = 16 A	— — 10 40 — — 25 — — 1.3 — 2.3 — 6.0 8.5 — 4.8 7.3 46 92 — — 2590 3365 — 135 200 — 440 — — 1.0 1.5 — 4.8 — — 13 — — 9.9 — — 43 — — 43 —	11152		
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 16 A	46	92	_	S
Input capacitance)	C _{iss}			2590	3365	pF
Reverse transfer	capacitance	C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	135	200	
Output capacitance		Coss		_	440	_	
Gate resistance		rg	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	1.0	1.5	Ω
Switching time	Rise time	t _r	ACS 0 A D S O A O D S O A O D S O A O D S O A O D S O A O D D S O D D	_	4.8	_	ns
	Turn-on time	t _{on}		_	13	_	
	Fall time	t _f		_	9.9	_	
	Turn-off time	t _{off}	$V_{DD} \approx 20 \text{ V}$ Duty \leq 1%, $t_W = 10 \mu\text{s}$	_	43	_	
Total gate charge	otal gate charge		$V_{DD} \approx 32 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 32 \text{ A}$	_	43	_	
(gate-source plus	gate-drain)	Qg	$V_{DD} \approx 32 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 32 \text{ A}$	_	_ 23		
Gate-source charge 1		Q _{gs1}	$V_{DD} \approx 32 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 32 \text{ A}$	_	7.9	_	nC
Gate-drain ("Miller") charge		Q _{gd}			8.4	_	
Gate switch charg	де	Q _{SW}		_	13	_	

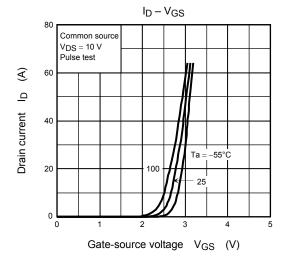
Source-Drain Ratings and Characteristics (Ta = 25°C)

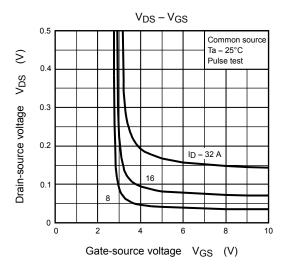
Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit	
Drain reverse current	Pulse	(Note 1)	I _{DRP}	_	_	_	96	Α
Forward voltage (diode)			V_{DSF}	$I_{DR} = 32 \text{ A}, V_{GS} = 0 \text{ V}$		_	-1.2	V

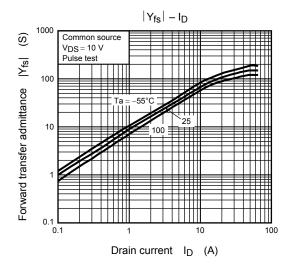
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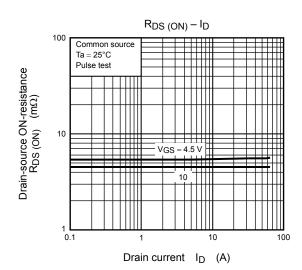


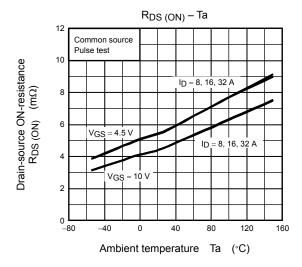


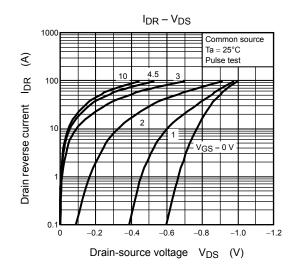


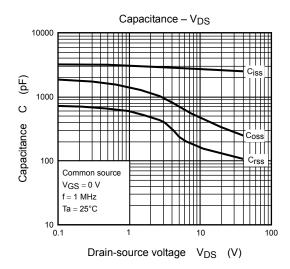


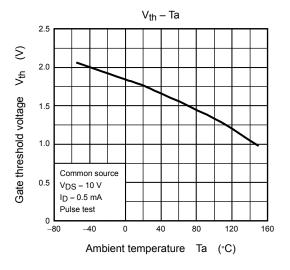


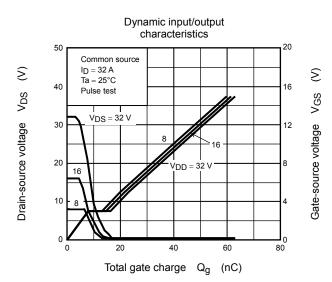




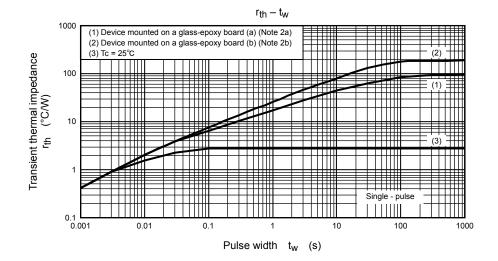


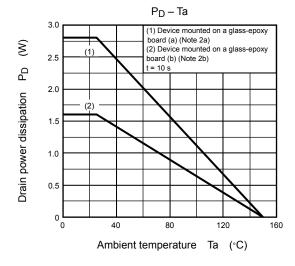


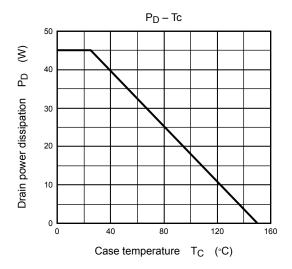


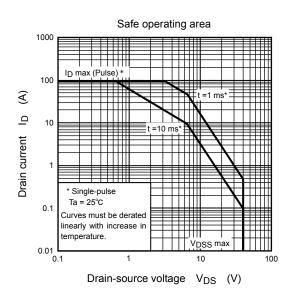


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